Dark Silicon & Modern Computer Architecture

Hung-Wei Tseng



Power v.s. Energy

- Power is the direct contributor of "heat"
 - Packaging of the chip
 - Heat dissipation cost
 - Power = $P_{Dynamic} + P_{static}$
- Energy = P * ET
 - The electricity bill and battery life is related to energy!
 - Lower power does not necessary means better battery life if the processor slow down the application too much

ergy! Pattery life if the

Dennardian Broken

Given a scaling factor S

Parameter	Relation	Classical Scaling	Leakage Limited
Power Budget		1	1
Chip Size		1	1
Vdd (Supply Voltage)		1/S	1
Vt (Threshold Voltage)	1/S	1/S	1
tex (oxide thickness)		1/S	1/S
W, L (transistor		1/S	1/S
Cgate (gate capacitance)	WL/tox	1/S	1/S
Isat (saturation current)	WVdd/tox	1/S	1
F (device frequency)	Isat/(CgateVdd)	S	S
D (Device/Area)	1/(WL)	S ²	S ²
p (device power)	IsatVdd	1/S ²	1
P (chip power)	Dp	1	S ²
U (utilization)	1/P	1	1/S ²

Dark Silicon and the End of Multicore Scaling

H. Esmaeilzadeh, E. Blem, R. St. Amant, K. Sankaralingam and D. Burger University of Washington, University of Wisconsin—Madison, University of Texas at Austin, Microsoft Research

Power consumption to light on all transistors

Chip												
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						
1	1	1	1	1	1	1						

Dennardian Scaling

Chip

0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5
0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5	0.5

=50W

=49W

Dennardian Broken

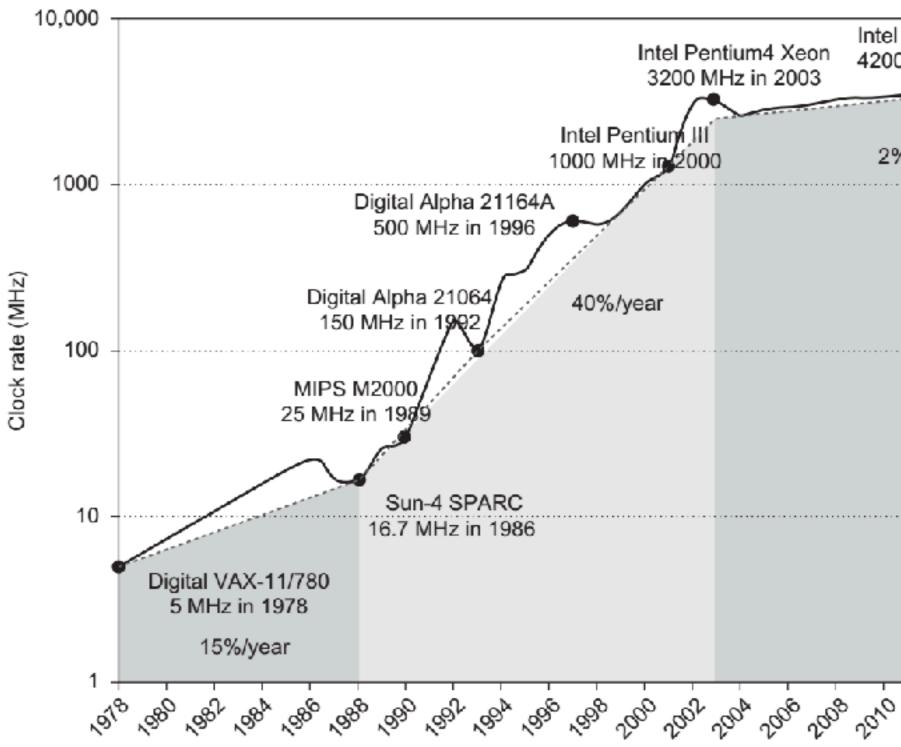


=100W!

What happens if power doesn't scale with process technologies?

- If we are able to cram more transistors within the same chip area (Moore's law continues), but the power consumption per transistor remains the same. Right now, if we power the chip with the same power consumption but put more transistors in the same area because the technology allows us to. How many of the following statements are true?
 - ① The power consumption per chip will increase
 - ² The power density of the chip will increase
 - Given the same power budget, we may not able to power on all chip area if we maintain the (3) same clock rate
 - ④ Given the same power budget, we may have to lower the clock rate of circuits to power on all chip area
 - A. 0
 - B. 1
 - C. 2
 - D. 3

Clock rate improvement is limited nowadays





Skylake Core i7 0 MHz in 2017	
%/year	
2012 2014 2010	 20 ¹ 0

Solutions/trends in dark silicon era

Trends in the Dark Silicon Era

- Aggressive dynamic voltage/frequency scaling
- Throughout oriented slower, but more
- Just let it dark activate part of circuits, but not all
- From general-purpose to domain-specific ASIC



Aggressive dynamic frequency scaling

More cores per chip, slower per core

Products	Solutions Support		(intel)		
		X Intel® Xeon® Processor E7-8890 v4	Intel® Xeon® Processor E7-8893 v4		
	Status	Launched	Launched		
	Launch Date 🚯	Q2'16	Q2'16		
	Lithography 🜖	14 nm	14 nm		
	Performance				
	# of Cores 🜖	24	4		
	# of Threads 🟮	48	8		
	Processor Base Frequency 🧿	2.20 GHz	3.20 GHz		
	Max Turbo Frequency 🕕	3.40 GHz	3.50 GHz		
	Cache 🚯	60 MB	60 MB		
	Bus Speed 🚯	9.6 GT/s	9.6 GT/s		
	# of QPI Links 🟮	3	3		
	TDP 🟮	165 W	140 W		

.

×	Intel® Xeon® Processor E7-8880 v4	×	
	Launched Q2'16 14 nm		
	22		
	44		
	2.20 GHz		
	3.30 GHz		

55 MB

9.6 GT/s

3

150 W

Dynamic/Active Power

- The power consumption due to the switching of transistor states
- Dynamic power per transistor $P_{dynamic} \sim \alpha \times C \times V^2 \times f \times N$
 - α : average switches per cycle
 - C: capacitance
 - *V*: voltage
 - f: frequency, usually linear with V
 - N: the number of transistors



Demo

- You may use cat /proc/cpuinfo to see all the details of your processors
- You may add "| grep MHz" to see the frequencies of your cores
- Only very few of them are on the boosted frequency

Static/Leakage Power

- The power consumption due to leakage transistors do not turn all the way off during no operation
- Becomes the dominant factor in the most advanced process technologies.
 - P_{leakage} ~ How about static power?
 - N: number of transistors
 - V: voltage
 - V_t : threshold voltage where transistor conducts (begins to switch)



Figure 1: Leakage power becomes a growing problem as demands for more performance and functionality drive chipmakers to nanometer-scale process nodes (Source: IBS).



Slower, but more



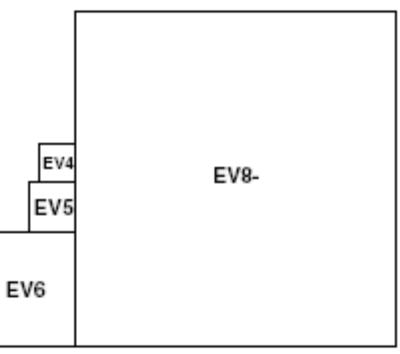
Single-ISA Heterogeneous Multi-Core Architectures: The Potential for Processor Power Reduction

Rakesh Kumar, Keith Farkas, Norm P. Jouppi, Partha Ranganathan, Dean M. Tullsen. University of California, San Diego and HP Labs

Areas of different processor generations

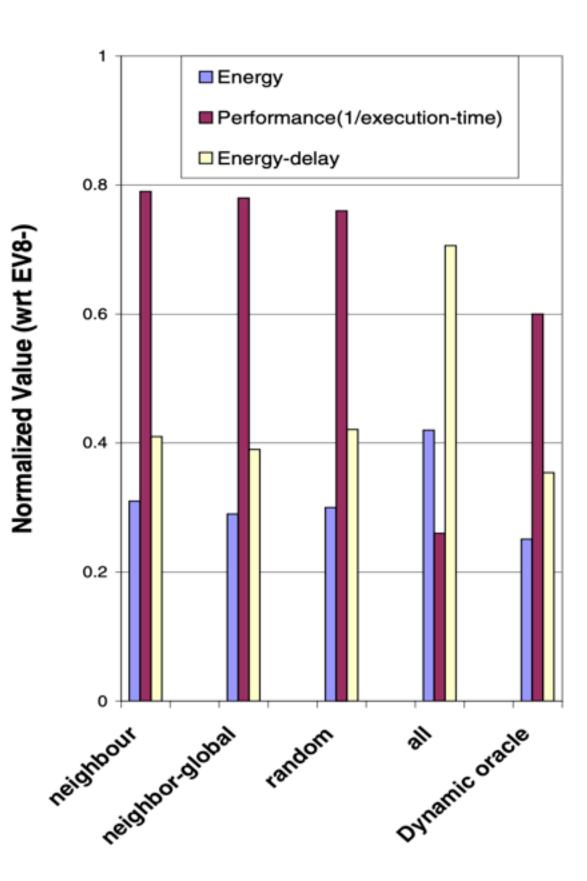
- You fit about 5 EV5 cores within the same area of an EV6
- If you build a quad-core EV6, you can use the same area to
 - build 20-core EV5 •
 - 3EV6+5EV5

Processor	EV5	EV6	EV6+
Issue-width	4	б (ООО)	6 (000)
I-Cache	8KB, DM	64KB, 2-way	64KB, 2-way
D-Cache	8KB, DM	64KB, 2-way	64KB, 2-way
Branch Pred.	2K-gshare	hybrid 2-level	hybrid 2-level
Number of MSHRs	4	8	16
Number of threads	1	1	4
Area (in mm^2)	5.06	24.5	29.9



Energy-delay

Energy * delay = Power * ET * ET = Power * ET²



Benchmark	Total	%	of instru	ctions per	core	Energy	ED	ED^2	Perf.
	switches	EV4 EV5 EV6 EV8- S		Savings(%)	Savings(%)	Savings(%)	Loss (%)		
ammp	0	0	0	0	100	0	0	0	0
applu	27	2.2	0.1	54.5	43.2	42.7	38.6	33.6	7.1
apsi	2	0	0	62.2	37.8	27.6	25.3	22.9	3.1
art	0	0	0	100	0	74.4	73.5	72.6	3.3
equake	20	0	0	97.9	2.1	72.4	71.3	70.1	3.9
fma3d	0	0	0	0	100	0	0	0	0
wupwise	16	0	0	99	1	72.6	69.9	66.2	10.0
bzip	13	0	0.1	84.0	15.9	40.1	38.7	37.2	2.3
crafty	0	0	0	0	100	0	0	0	0
eon	0	0	0	100	0	77.3	76.3	75.3	4.2
gzip	82	0	0	95.9	4.1	74.0	73.0	71.8	3.9
mcf	0	0	0	0	100	0	0	0	0
twolf	0	0	0	0	100	0	0	0	0
vortex	364	0	0	73.8	26.2	56.2	51.9	46.2	9.8
Average	1(median)	0.2%	0%	54.8%	45.0%	38.5%	37.0%	35.4%	3.4%

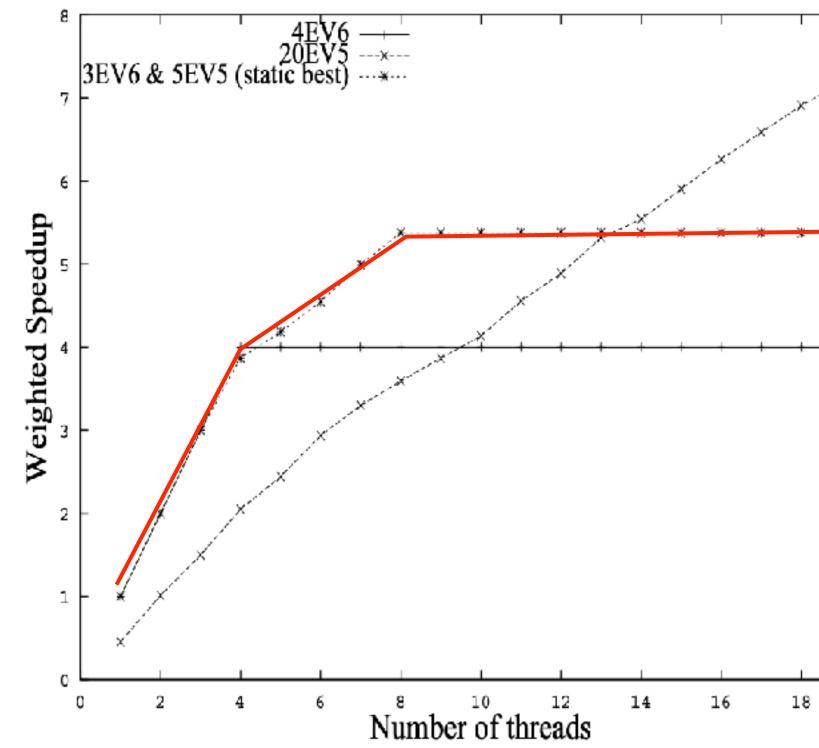
Single ISA heterogeneous CMP

- Regarding "Single-ISA Heterogeneous Multi-Core Architectures", how many of the following statements is/are correct?
 - ① You need to recompile and optimize the binary for each core architecture to exploit the threadlevel parallelism in this architecture

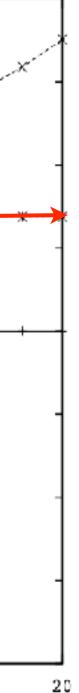
 - For a program with limited thread-level parallelism, single ISA heterogeneous CMP would deliver better or at least the same level of performance than homogeneous CMP ③ For a program with rich thread-level parallelism, single ISA heterogeneous CMP would deliver better or at least the same level of performance than homogeneous CMP built with oldergeneration cores
 - ④ Spending more time on older-generation cores would always lead to better energy-delay
 - A. 0 B. 1 C. 2 D. 3 E. 4



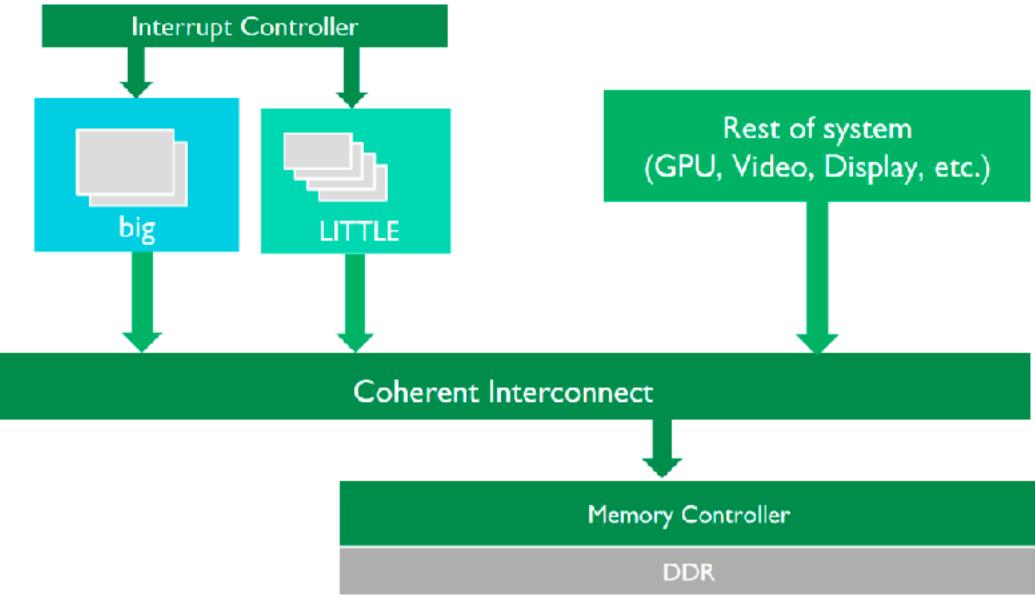
4EV6 v.s. 20 EV5 v.s. 3EV6+5EV5





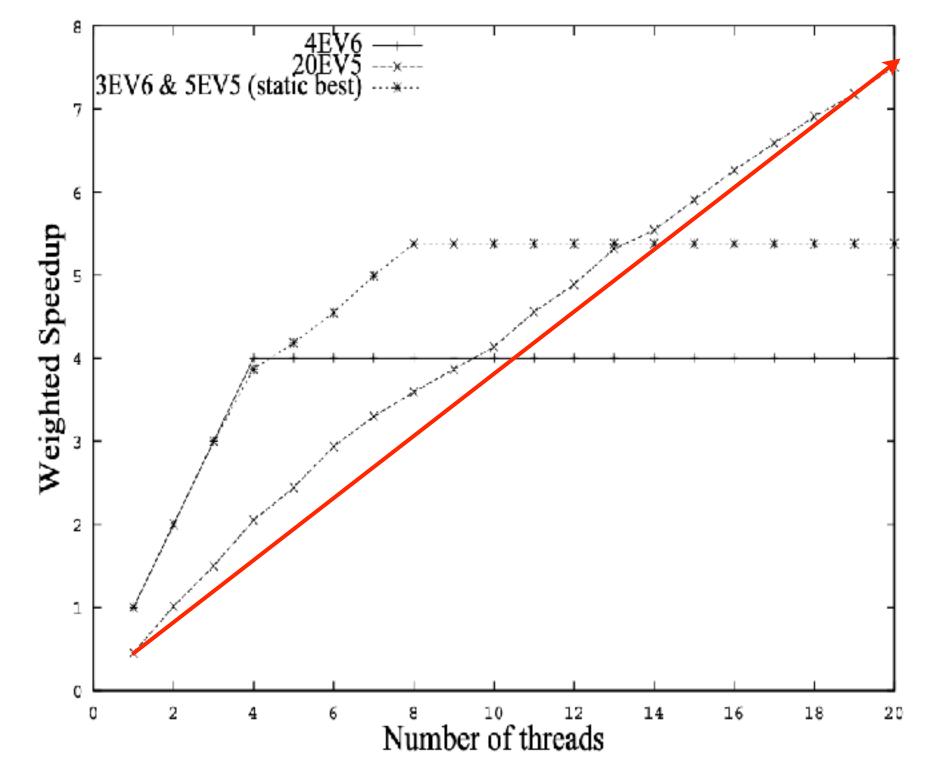


ARM's big.LITTLE architecture big.LITTLE system





4EV6 v.s. 20 EV5 v.s. 3EV6+5EV5





Xeon Phi

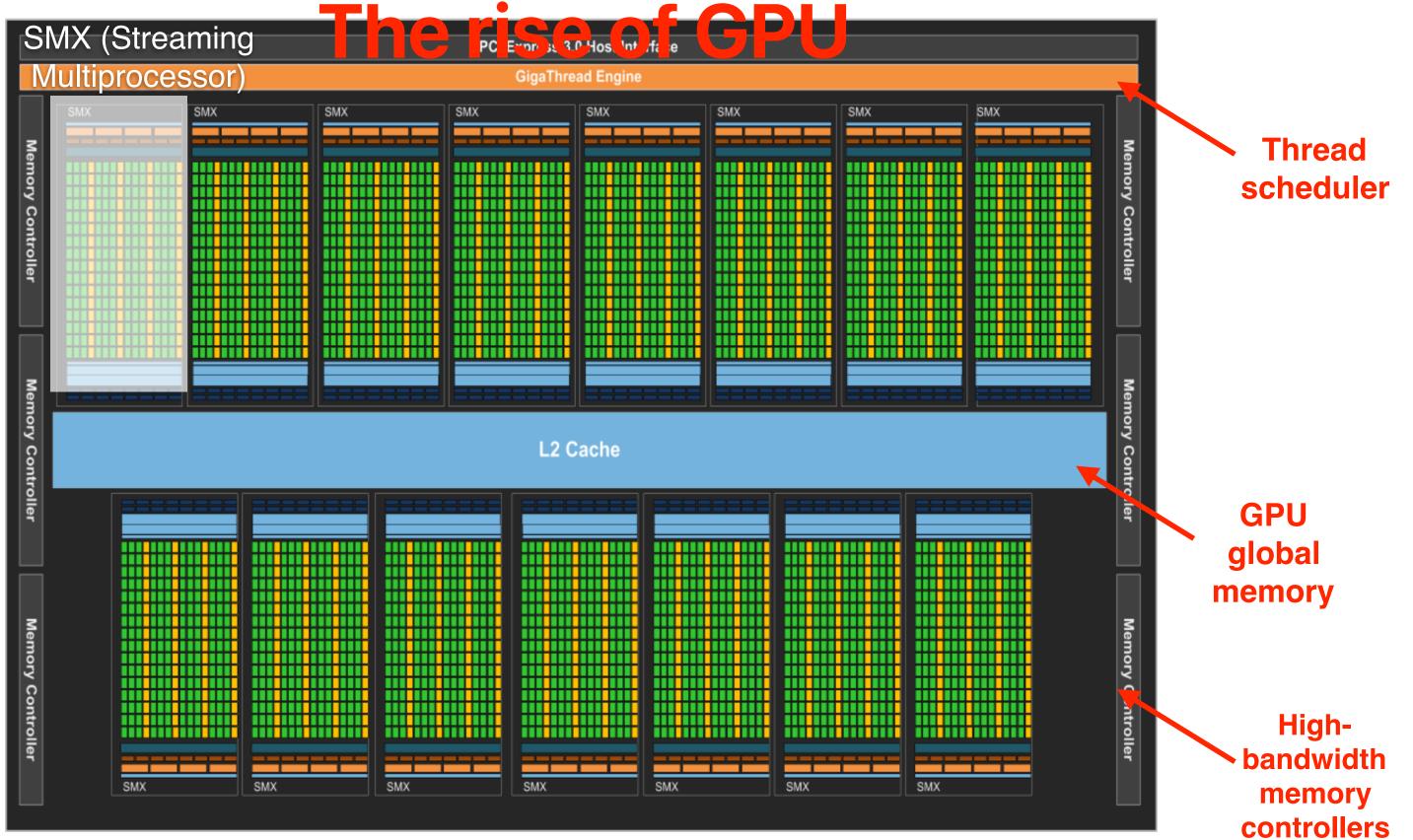
Essentials

Product Collection	Intel® Xeon Phi™ 72x5 Processor Family
Code Name	Products formerly Knights Mill
Vertical Segment	Server
Processor Number	7295
Off Roadmap	No
Off Roadmap Status	No Launched
-	
Status	Launched

Performance

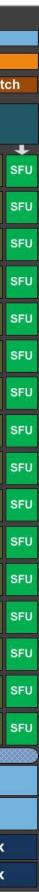
# of Cores 👔	72
# of Threads 🕐	72
Processor Base Frequency 🕜	1.50 GHz
Max Turbo Frequency 😨	1.60 GHz
Cache 🕐	36 MB L2 Cache
TDP (?)	320 W





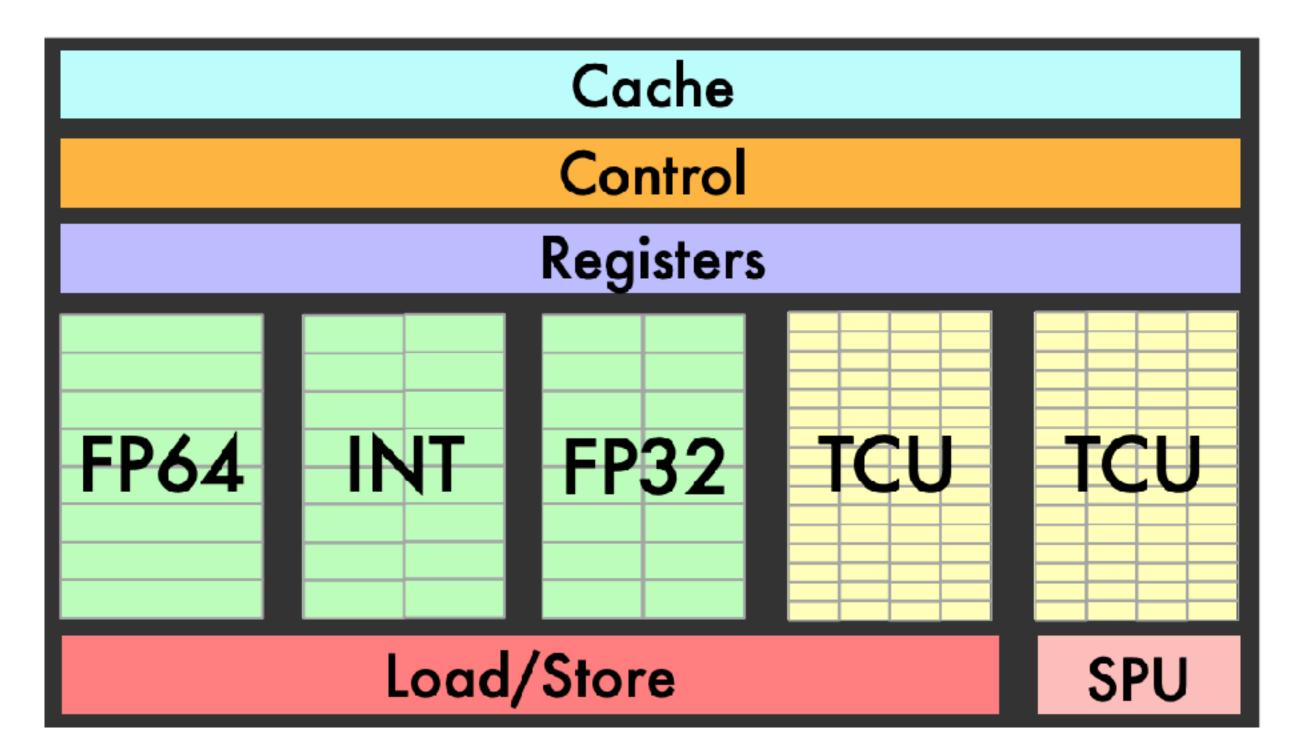
Each of these performs the same operation, but each of these is also a "thread"

SMX																		
				_	Instruction Cache Warp Scheduler Warp Scheduler								1					
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	Dispatch Dispatch							icn		spatc		Dispat	len		ispato •		Dispat	
				Regi	ster	File (65,536	x 32-	bit G	K110) (1:	31,07	2 x32-l	oit Gl	(210))		
	+	+	+	+	+ +		+	+ +		+	+	+	+	+	+	+	+	+
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core		DP Unit		SFU	Core	Core	Core	DP Unit	Core			DP Unit	LD/ST
Core	Core	Core	DP Jnit	0	Ld	ore	P Jnit	.D, T	SFU		Core	ore		re	Gl	J. re	es	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST	SFU	Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core					DP Unit	-		Core	Core	Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit		SFU				DP Unit		Core	Core	DP Unit	LD/ST
Core							DP Unit	-					DP Unit		Core	Core	DP Unit	LD/ST
Core	Core	Core	DP Unit	Core	Core	Core	DP Unit			Core ect Net		Core	DP Unit	Core	Core	Core	DP Unit	LD/ST
	(64 <u>K</u>	B Shar	ed Me	emor	y / <u>L1</u>	l Cache	~~~~~~				Share	ed Mem	ory /	L1 C	ache	GK21	0)
							48 K				_							
	Tex		Tex		Tex			Tex	¢		Tex		Tex		Tex			Tex
	Tex		Tex	:		Tex		Te>	٢		Tex		Tex	¢	Tex		Tex	
									3	SU								



Just let it dark

NVIDIA's Turing Architecture





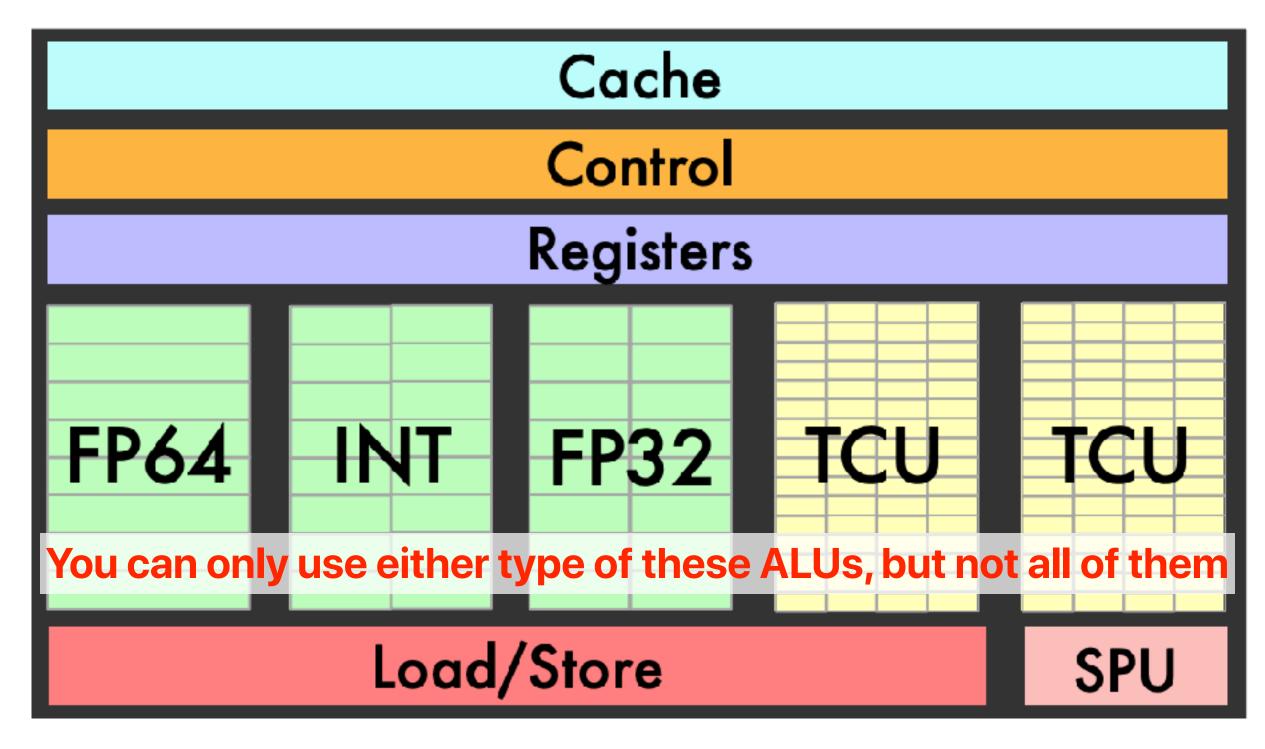
Programming in Turing Architecture

Use tensor cores cublasErrCheck(cublasSetMathMode(cublasHandle, CUBLAS_TENSOR_OP_MATH)); Make them 16-bit convertFp32ToFp16 <<< (MATRIX_M * MATRIX_K + 255) / 256, 256 >>> (a_fp16, a_fp32, MATRIX_M * MATRIX_K); convertFp32ToFp16 <<< (MATRIX_K * MATRIX_N + 255) / 256, 256 >>> (b_fp16, b_fp32, MATRIX K * MATRIX N);

cublasErrCheck(cublasGemmEx(cublasHandle, CUBLAS_OP_N, CUBLAS_OP_N, MATRIX_M, MATRIX_N, MATRIX_K, &alpha, a_fp16, CUDA_R_16F, MATRIX_M, b_fp16, CUDA_R_16F, MATRIX_K, &beta, c_cublas, CUDA_R_32F, MATRIX_M, CUDA_R_32F, CUBLAS_GEMM_DFALT_TENSOR_OP));

Gemm

NVIDIA's Turing Architecture

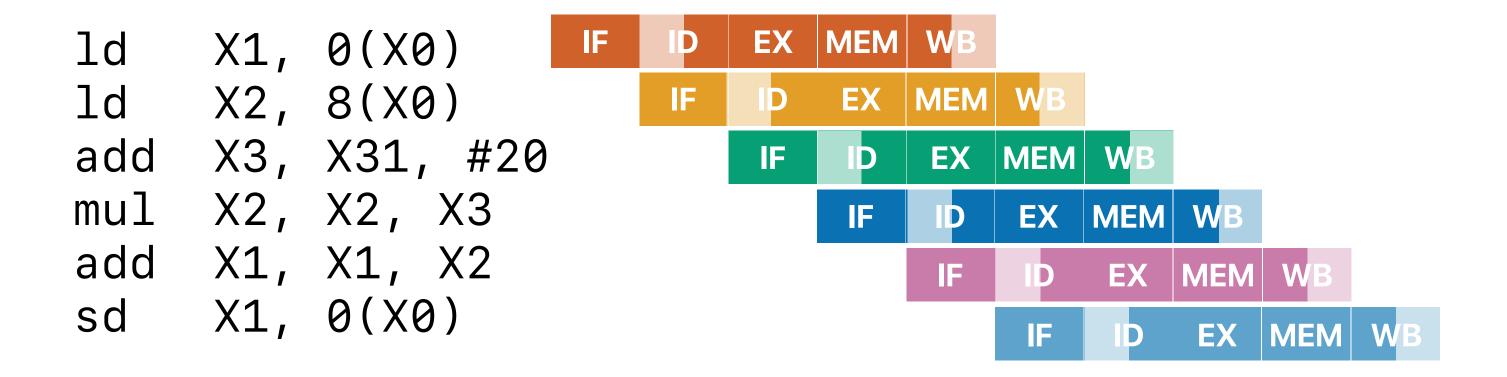




The rise of ASICs

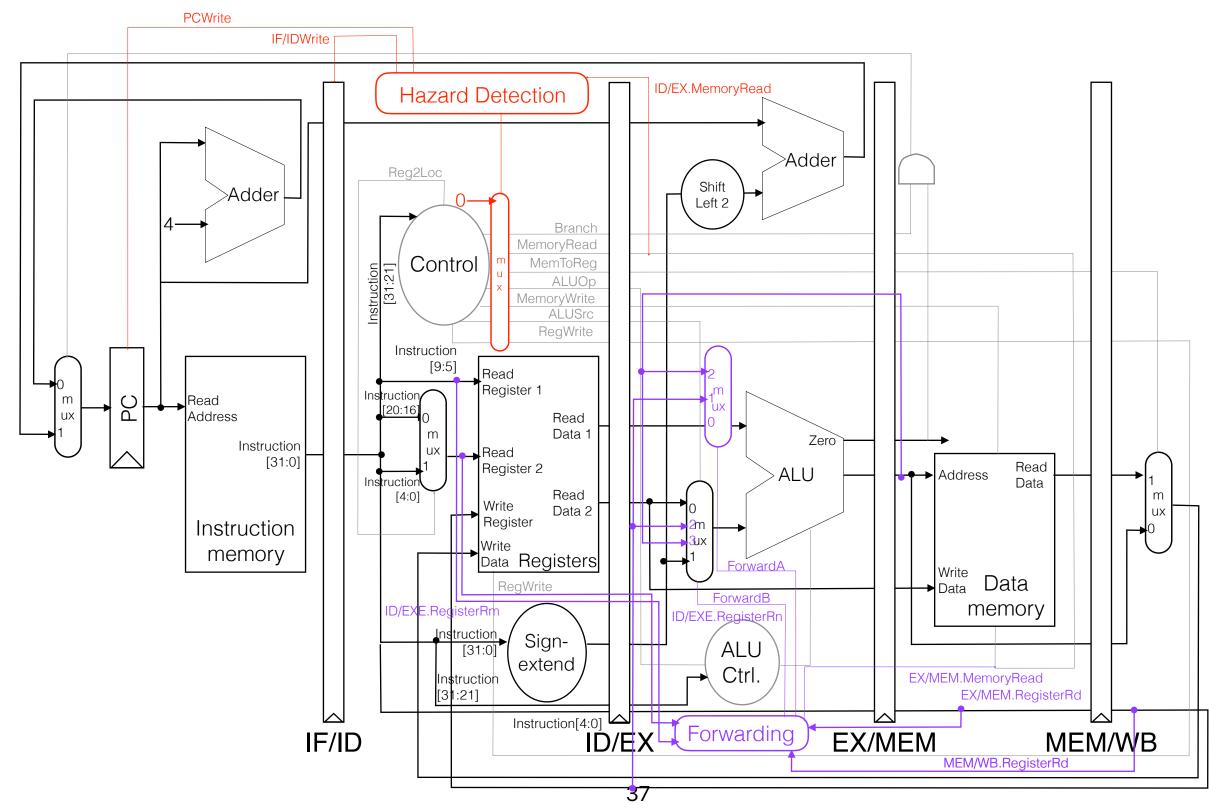
Say, we want to implement a[i] += a[i+1]*20

This is what we need in RISC-V in each iteration

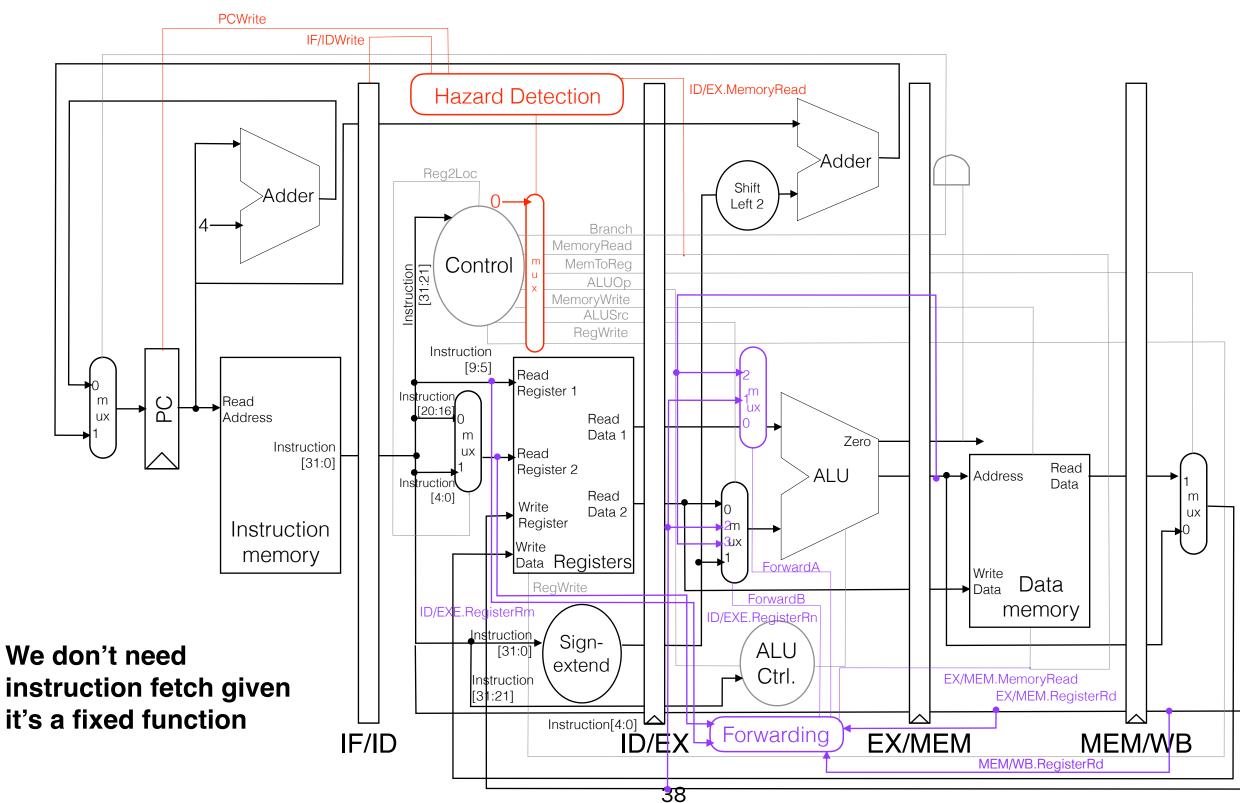




This is what you need for these instructions

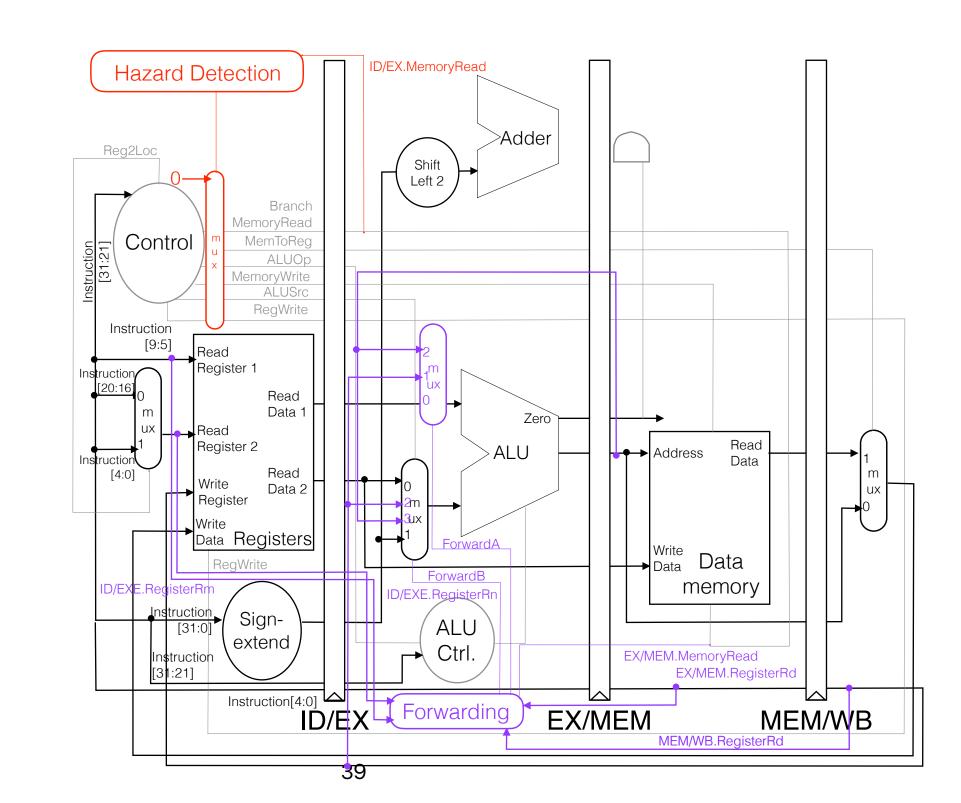


Specialize the circuit





Specialize the circuit

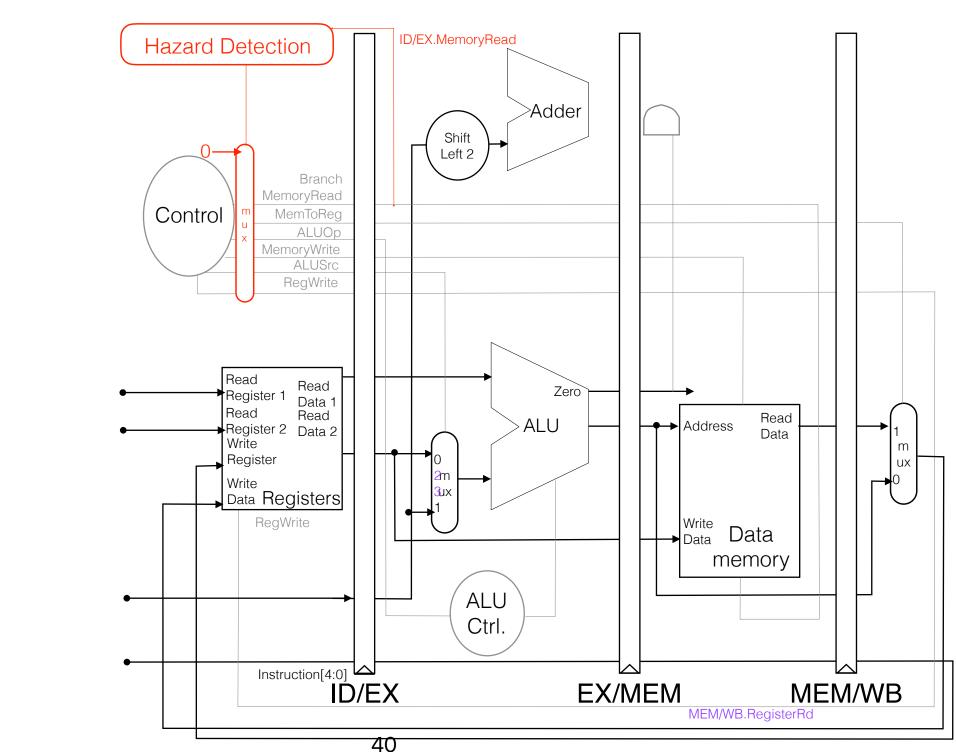


We don't need these many registers, complex control, decode

We don't need instruction fetch given it's a fixed function



Specialize the circuit



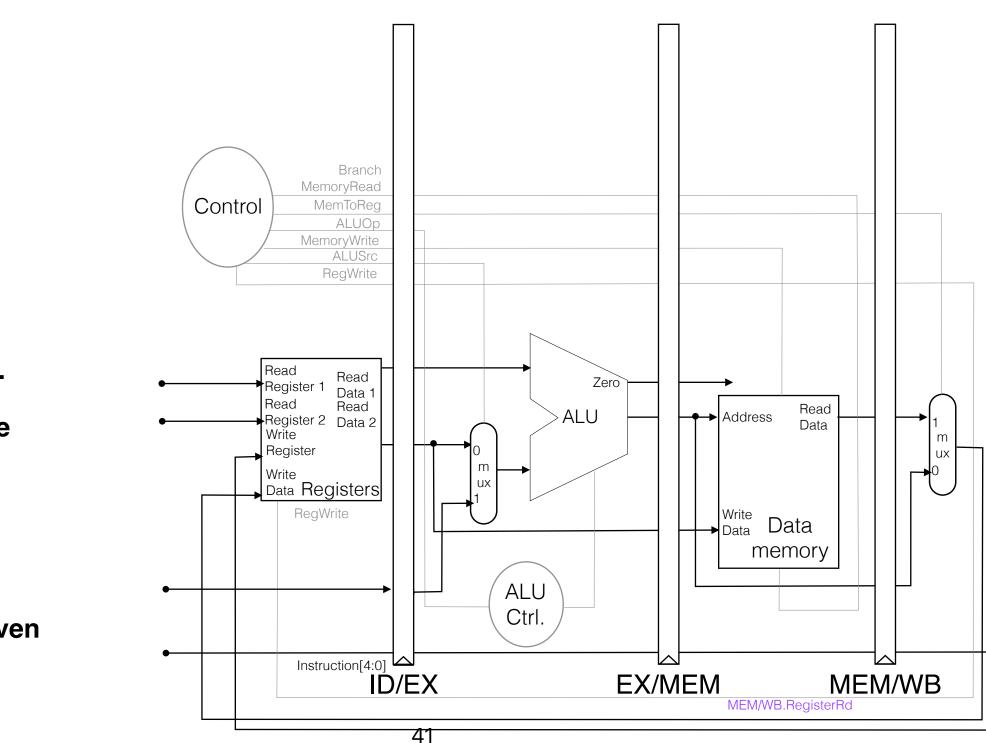
We don't need ALUs, branches, hazard detections...

We don't need these many registers, complex control, decode

We don't need instruction fetch given it's a fixed function



Specialize the circuit



We don't need big ALUs, branches, hazard detections...

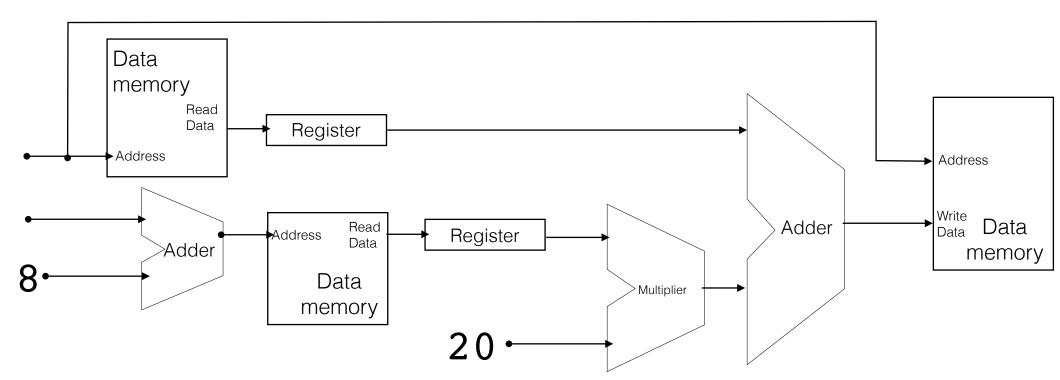
We don't need these many registers, complex control, decode

We don't need instruction fetch given it's a fixed function

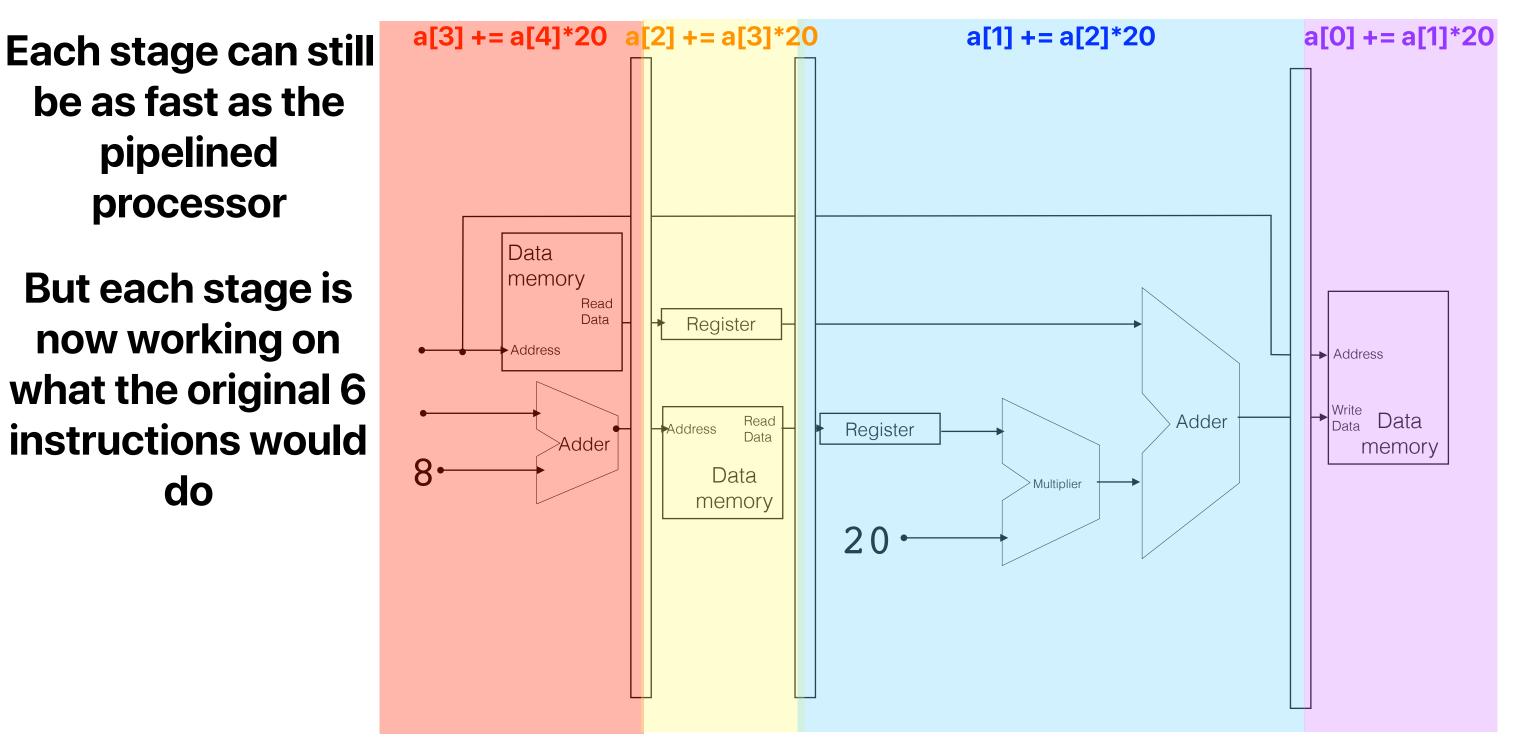


Rearranging the datapath

ld X1, 0(X0)
ld X2, 8(X0)
add X3, X31, #20
mul X2, X2, X3
add X1, X1, X2
sd X1, 0(X0)



The pipeline for a[i] += a[i+1]*20



A Cloud-Scale Acceleration Architecture

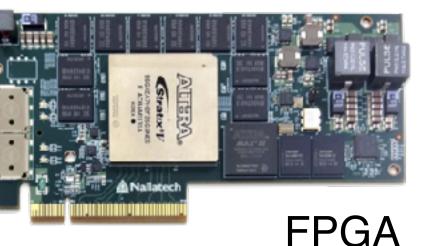
Adrian Caulfield, Eric Chung, Andrew Putnam, Hari Angepat, Jeremy Fowers, Michael Haselman, Stephen Heil, Matt Humphrey, Puneet Kaur, Joo-Young Kim, Daniel Lo, Todd Massengill, Kalin Ovtcharov, Michael Papamichael, Lisa Woods, Sitaram Lanka, Derek Chiou, **Doug Burger**

Microsoft

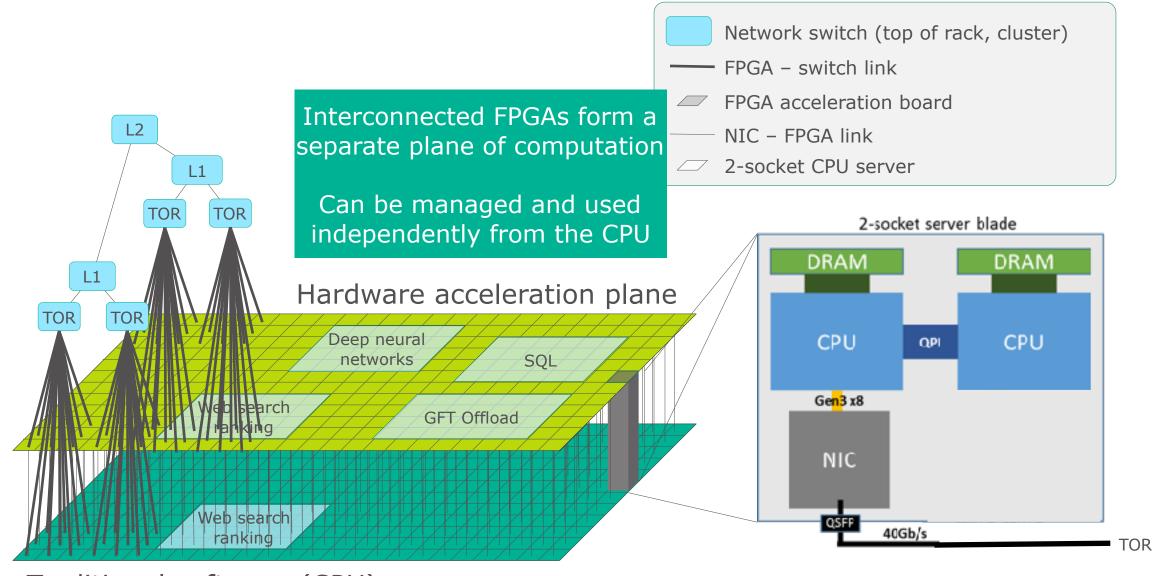




- Field Programmable Gate Array
 - An array of "Lookup tables (LUTs)"
 - Reconfigurable wires or say interconnects of LUTs
 - Registers
- An LUT
 - Accepts a few inputs
 - Has SRAM memory cells that store all possible outputs
 - Generates outputs according to the given inputs
- As a result, you may use FPGAs to emulate any kind of gates or logic combinations, and create an ASIC-like processor



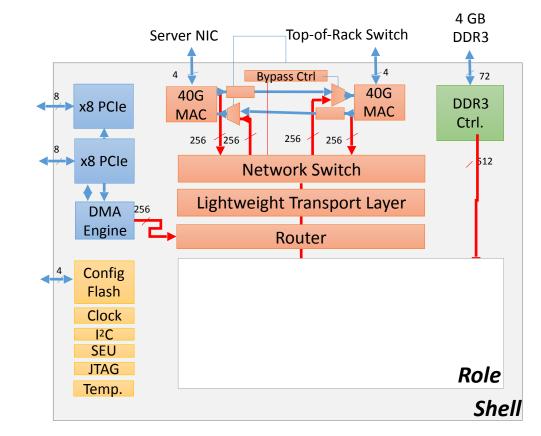
Configurable cloud



Traditional software (CPU) server plane

Gen2 shell

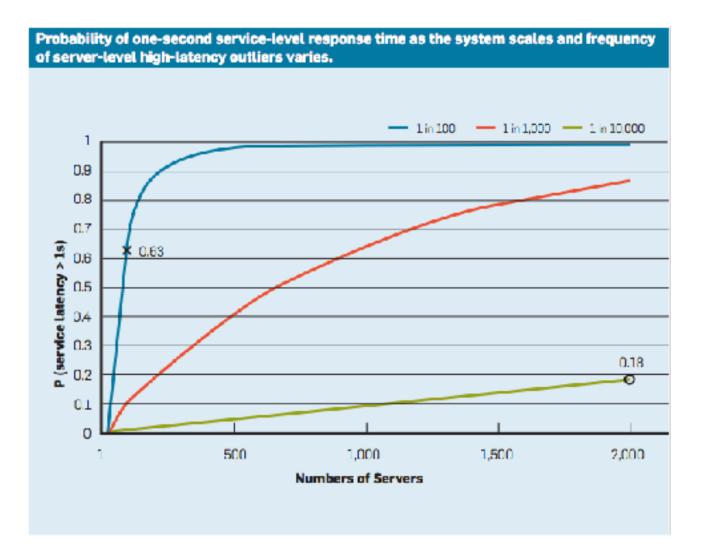
- Foundation for all accelerators
 - Includes PCIe, Networking and DDR IP
 - Common, well tested platform for development
- Lightweight Transport Layer
 - Reliable FPGA-to-FPGA Networking
 - Ack/Nack protocol, retransmit buffers
 - Optimized for lossless network
 - Minimized resource usage



Use cases

- Local: Great service acceleration
- Infrastructure: Fastest cloud network
- Remote: Reconfigurable app fabric (DNNs)

Tail latencies



- Why is this bad? Each user request experience tail is much higher
- If 99% of the server's response time is response

 - than 1 seconds.

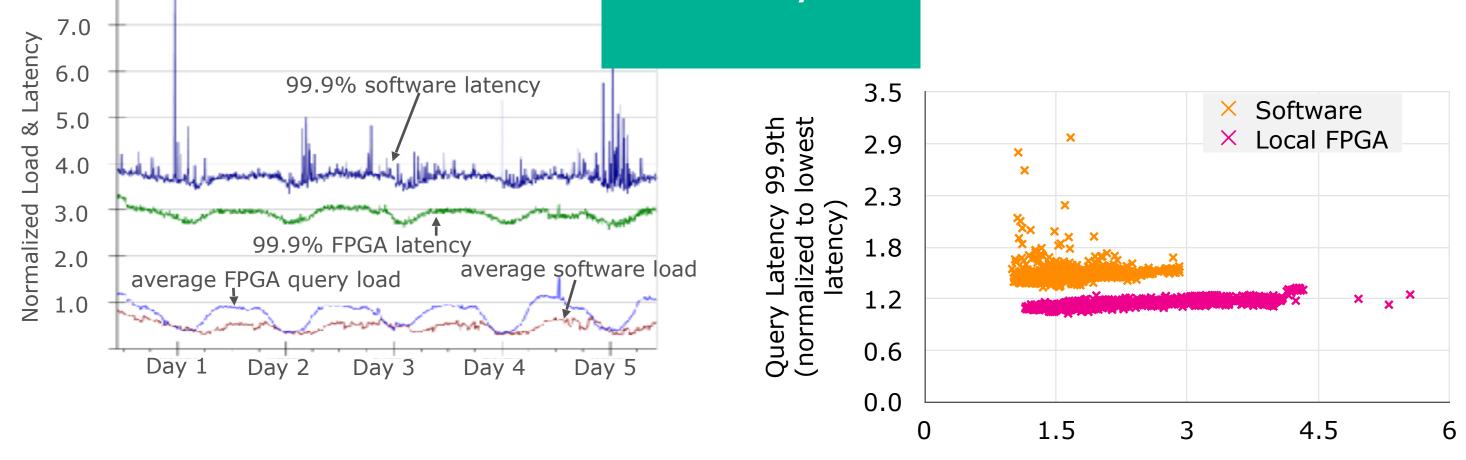
 Tail Latency == 1 in X servers being slow now needs several servers – Changes of 10ms, but 1% of them take 1 second to

• If the user only needs one, the mean is OK If the user needs 100 partitions from 100 servers, 63% of the requests takes more

5 day bed-level latency

- Lower & more consistent <u>99.9th tail latency</u>
- In production for years

Even at $2 \times$ query load, accelerated ranking has lower latency than software at any load





Query Load (normalized to lowest throughput)

Accelerated networking

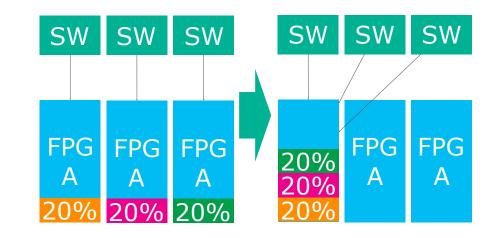
- Software defined networking
 - Generic Flow Table (GFT) rule based packet rewriting
 - 10x latency reduction vs software, CPU load now <1 core
 - 25Gb/s throughput at 25µs latency the fastest cloud network
- Capable of 40 Gb line rate encrypt and decrypt
 - On Haswell, AES GCM-128 costs 1.26 cycles/byte[1] (5+ 2.4Ghz cores to sustain 40Gb/s)
 - CBC and other algorithms are more expensive
 - AES CBC-128-SHA1 is 11µs in FPGA vs 4µs on CPU (1500B packet)
 - Higher latency, but significant CPU savings

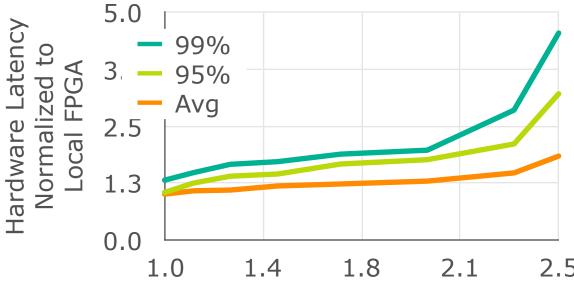


VMs • 40G NIC GFT 40G Crypto

Shared DNN

- Economics: consolidation
 - Most accelerators have more throughput than a single host requires
 - Share excess capacity, use fewer instances
 - Frees up FPGAs for other use services
- DNN accelerator
 - Sustains 2.5x busy clients in microbenchmark, before queuing delay drives latency up





2.5

Oversubscription: # Remote Clients / # FPGAs

MS' "Configurable Clouds"

- Regarding MS' configurable clouds that are powered by FPGAs, please identify how many of the following are correct
 - ① Each FPGA is dedicated to one machine

manager. Instead, this paper focuses first on the hardware architecture necessary to treat remote FPGAs as available resources for global acceleration pools. We describe the com-

- ② Each FPGA is connected through a network that is separated from the data center network
- ③ FPGA can deliver shorter average latency for AES-CBC-128-SHA1 encryption and decryption than Intel's high-end processors
- FPGA-accelerated search queries are always faster than a pure software-based datacenter
- A. 0 B. 1 C. 2 D. 3 E. 4

Datacenter networks handle multiple traffic classes and protocols, some of which expect near-lossless behavior. FP-GAs routing traffic between the server's NIC and TOR, as a bump-in-the-wire, must not interfere with the expected behavior of these various traffic classes. To that end, the LTL Protocol Engine shown in Figure 4 allows roles to send and receive packets from the network without affecting-and while supporting-existing datacenter protocols.

Our FPGA implementation supports full 40 Gb/s encryption and decryption. The worst case half-duplex FPGA crypto latency for AES-CBC-128-SHA1 is 11 μ s for a 1500B packet, from first flit to first flit. In software, based on the Intel numbers, it is approximately 4 μ s. AES-CBC-SHA1 is, however,

latencies begin exceeding acceptable thresholds. Because the FPGA is able to process requests while keeping latencies low, it is able to absorb more than twice the offered load, while executing queries at a latency that never exceeds the software datacenter at any load.





- Which of the following is the main reason why Microsoft adopts FPGAs instead of the alternatives chosen by their rivals?
 - A. Cost
 - B. Performance
 - C. Scalability
 - D. Flexibility
 - E. Easier to program

Why FPGA?

This model offers significant flexibility. From the local perspective, the FPGA is used as a compute or a network accelerator. From the global perspective, the FPGAs can be managed as a large-scale pool of resources, with acceleration

These programmable architectures allow for hardware homogeneity while allowing fungibility via software for different services. They must be highly *flexible* at the system even hyperscale infrastructure. The acceleration system we describe is sufficiently flexible to cover three scenarios: local compute acceleration (through PCIe), network acceleration, and global application acceleration, through configuration as pools of motely accessible FPGAs. Local acceleration handles high-

This paper described Configurable Clouds, a datacenterscale acceleration architecture, based on FPGAs, that is both scalable and flexible. By putting in FPGA cards both in I/O In addition to architectural requirements that provide sufficient flexibility to justify scale production deployment, there are also physical restrictions in current infrastructures that

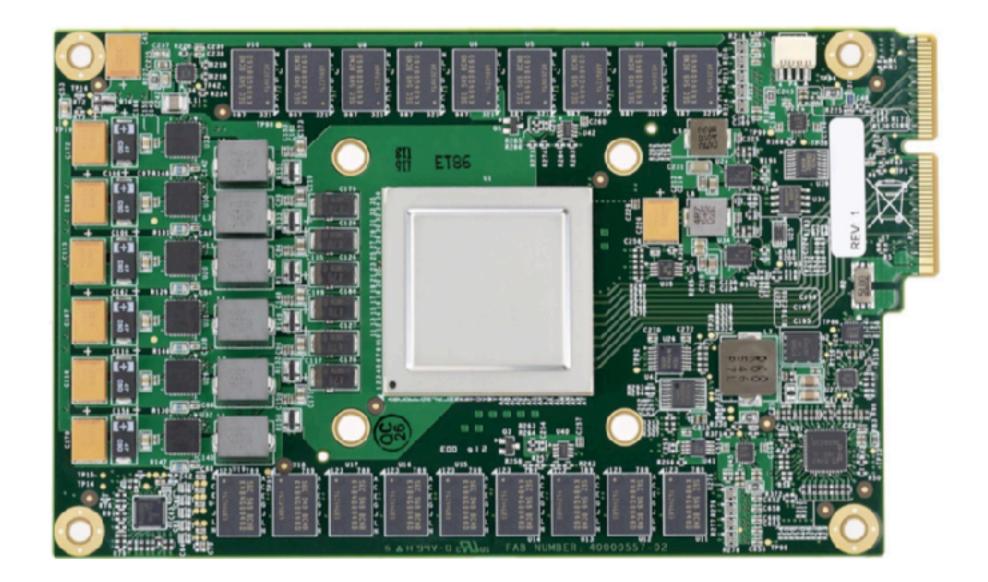
Summary: What makes a configurable cloud?

- Local, infrastructure and remote acceleration
 - Gen1 showed significant gains even for complex services (~2x for Bing)
 - Needs to have clear benefit for majority of servers: infrastructure
- Economics must work
 - What works at small scale doesn't always work at hyperscale and vice versa
 - Little tolerance for superfluous costs
 - Minimized complexity and risk in deployment and maintenance
- Must be flexible
 - Support simple, local accelerators and complex, shared accelerators at the same time
 - Rapid deployment of new protocols, algorithms and services across the cloud

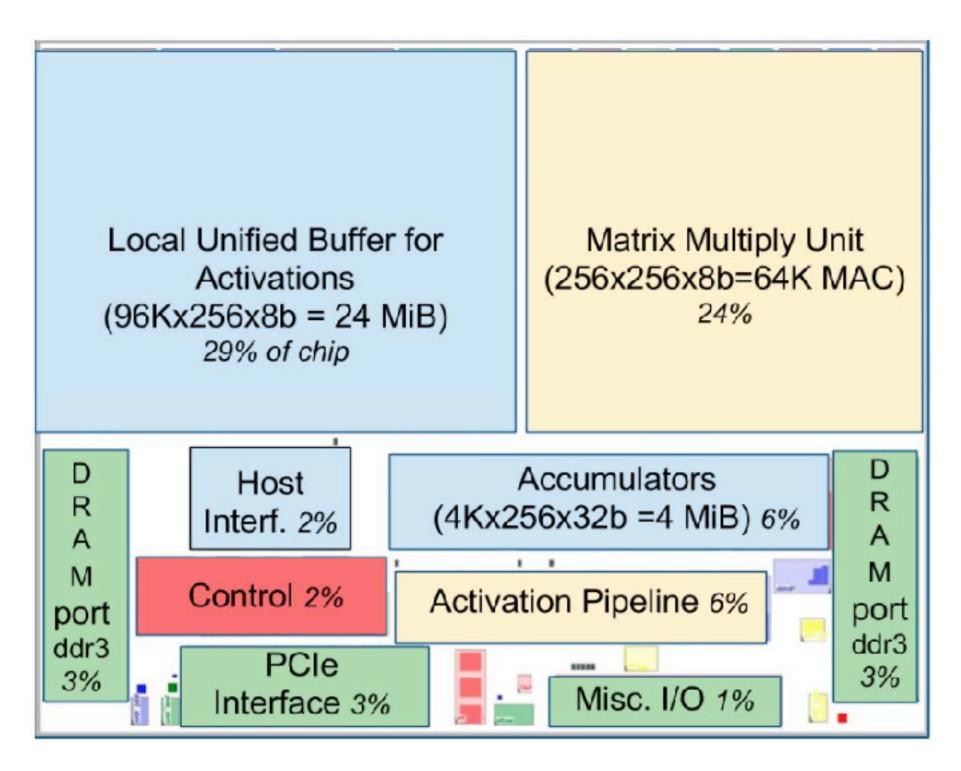
In-Datacenter Performance Analysis of a Tensor Processing Unit

N. P. Jouppi, C. Young, N. Patil, D. Patterson, G. Agrawal, R. Bajwa, S. Bates, S. Bhatia, N. Boden, A. Borchers, R. Boyle, P.-I. Cantin, C. Chao, C. Clark, J. Coriell, M. Daley, M. Dau, J. Dean, B. Gelb, T. V. Ghaemmaghami, R. Gottipati, W. Gulland, R. Hagmann, C. R. Ho, D. Hogberg, J. Hu, R. Hundt, D. Hurt, J. Ibarz, A. Jaffey, A. Jaworski, A. Kaplan, H. Khaitan, D. Killebrew, A. Koch, N. Kumar, S. Lacy, J. Laudon, J. Law, D. Le, C. Leary, Z. Liu, K. Lucke, A. Lundin, G. MacKean, A. Maggiore, M. Mahony, K. Miller, R. Na-garajan, R. Narayanaswami, R. Ni, K. Nix, T. Norrie, M. Omernick, N. Penukonda, A. Phelps, J. Ross, M. Ross, A. Salek, E. Samadiani, C. Severn, G. Sizikov, M. Snelham, J. Souter, D. Steinberg, A. Swing, M. Tan, G. Thorson, B. Tian, H. Toma, E. Tuttle, V. Vasudevan, R. Wal-ter, W. Wang, E. Wilcox, and D. H. Yoon Google Inc.

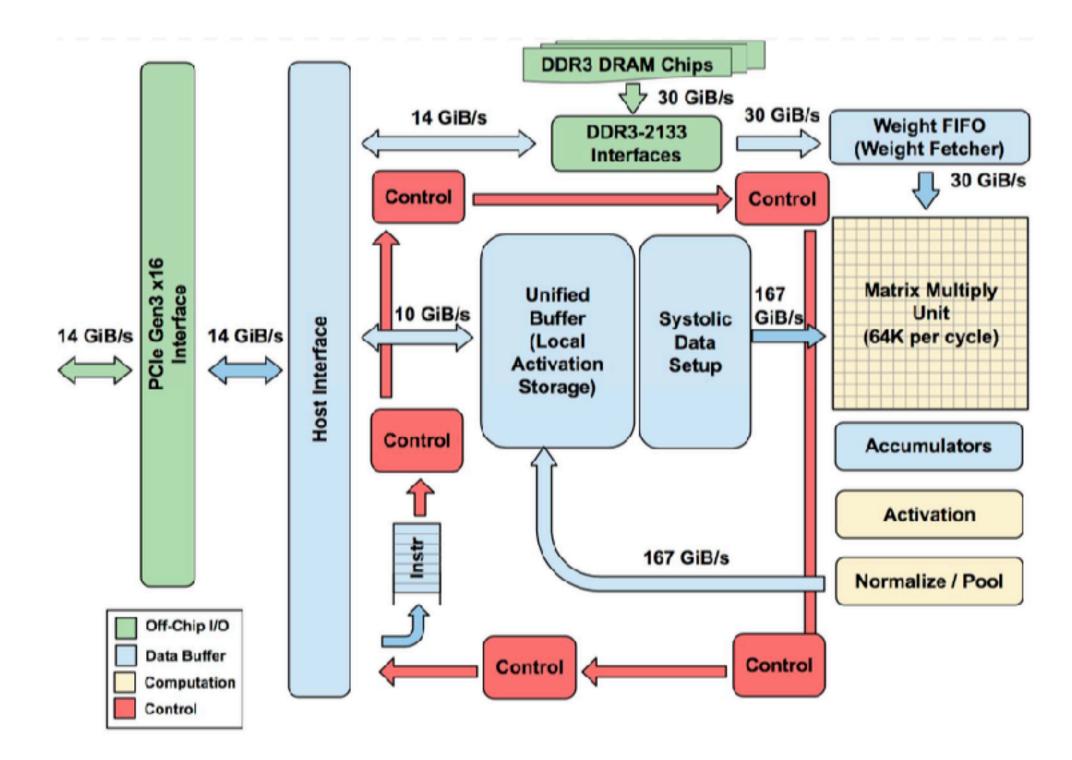
What TPU looks like



TPU Floorplan



TPU Block diagram



TPU (Tensor Processing Unit)

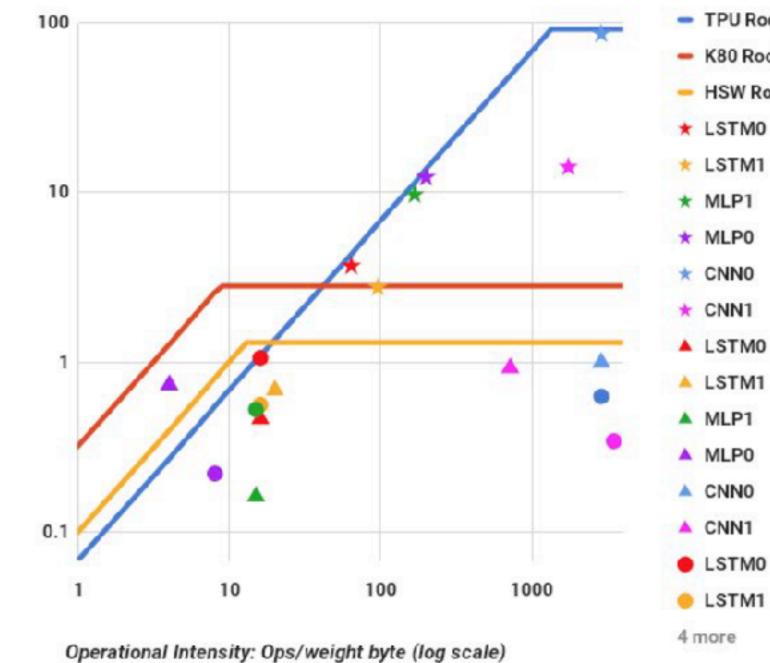
- Regarding TPUs, please identify how many of the following statements are correct.
 - ① TPU is optimized for highly accurate matrix multiplications TPU is designed for dense matrices, not for sparse matrices A majority of TPU's area is used by memory buffers ④ All TPU instructions are equally long
 - A. 0
 - B. 1
- C. 2 D. 3
 - E. 4



Experimental setup

	Die									Benchmarked Servers					
Model	mm²	nm	MHz	TDP	Measured		TOPS/s		GB/s	On-Chip	Dies	s DRAM Size	TDP	Measured	
					Idle	Busy	8b	FP	GD/S	Memory	Dies	DIAM SIZE	IDP	Idle	Busy
Haswell E5-2699 v3	662	22	2300	145 W	41 W	1 45W	2.6	1.3	51	51 MiB	2	256 GiB	504W	159W	455W
NVIDIA K80 (2 dies/card)	561	28	560	1 50W	25W	98W		2.8	1 60	8 MiB	8	256 GiB (host) + 12 GiB x 8	1 838W	357W	991W
TPU	NA*	28	700	75W	28W	40W	92		34	28 MiB	4	256 GiB (host) + 8 GiB x 4	861W	290W	384W

Performance/Rooflines



TeraOps/sec (log scale)



- TPU Roofline
- K80 Roofline
- HSW Roofline

Tail latency

_					
	Туре	Batch	99th% Response	Inf/s (IPS)	% Max IPS
(CPU	16	7.2 ms	5,482	42%
	CPU	64	21.3 ms	13,194	100%
	GPU	16	6.7 ms	13,461	37%
	GPU	64	8.3 ms	36,465	100%
'	TPU	200	7.0 ms	225,000	80%
<u>'</u>	TPU	250	10.0 ms	280,000	100%

Table 4. 99-th% response time and per die throughput (IPS) for MLP0 as batch size varies for MLP0. The longest allowable latency is 7 ms. For the GPU and TPU, the maximum MLP0 throughput is limited by the host server overhead. Larger batch sizes increase throughput, but as the text explains, their longer response times exceed the limit, so CPUs and GPUs must use less-efficient, smaller batch sizes (16 vs. 200).



What NVIDIA says

https://blogs.nvidia.com/blog/2017/04/10/ai-drives-rise-accelerated-computing-datacenter/

	K80 2012	TPU 2015	P40 2016	
Inferences/Sec <10ms latency	¹ / ₁₃ X	1X	2X	
Training TOPS	6 FP32	NA	12 FP32	
Inference TOPS	6 FP32	90 INT8	48 INT8	
On-chip Memory	16 MB	24 MB	11 MB	
Power	300W	75W	250W	
Bandwidth	320 GB/S	While Google and NVIDIA chose different development paths, there were sevel both our approaches. Specifically:		

- · Al requires accelerated computing. Accelerators provide the significant data processing necessary to keep up with the growing demands of deep learning in an era when Moore's law is slowing.
- Tensor processing is at the core of delivering performance for deep learning training and inference.
- Tensor processing is a major new workload enterprises must consider when building modern data. centers.
- Accelerating tensor processing can dramatically reduce the cost of building modern data centers.

ral themes common to

7.10 Fallacies and Pitfalls

In these early days of both DSAs and DNNs, fallacies abound.

Fallacy It costs \$100 million to design a custom chip.

Figure 7.51 shows a graph from an article that debunks the widely quoted \$100million myth that it was "only" \$50 million, with most of the cost being salaries (Olofsson, 2011). Note that the author's estimate is for sophisticated processors that include features that DSAs by definition omit, so even if there were no improvement to the development process, you would expect the cost of a DSA design to be less.

Why are we more optimistic six years later, when, if anything, mask costs are even higher for the smaller process technologies?

First, software is the largest category, at almost a third of the cost. The availability of applications written in domain-specific languages allows the compilers to do most of the work of porting the applications to your DSA, as we saw for the TPU and Pixel Visual Core. The open RISC-V instruction set will also help reduce the cost of getting system software as well as cut the large IP costs.

Mask and fabrication costs can be saved by having multiple projects share a single reticle. As long as you have a small chip, amazingly enough, for \$30,000 anyone can get 100 untested parts in 28-nm TSMC technology (Patterson and Nikolić, 2015).

Fallacies & Pitfalls

- Fallacy: NN inference applications in data centers value throughput as much as response time.
- Fallacy: The K80 GPU architecture is a good match to NN inference GPU is throughput oriented
- Pitfall: For NN hardware, Inferences Per Second (IPS) is an inaccurate summary performance metric — it's simply the inverse of the complexity of the typical inference in the application (e.g., the number, size, and type of NN layers)
- Fallacy: The K80 GPU results would be much better if Boost mode were enabled Boost mode increased the clock rate by a factor of up to 1.6—from 560 to 875 MHz which increased performance by 1.4X, but it also raised power by 1.3X. The net gain in performance/Watt is 1.1X, and thus Boost mode would have a minor impact on LSTM1 Fallacy: CPU and GPU results would be comparable to the TPU if we used them more
- efficiently or compared to newer versions.

Fallacies & Pitfalls

- Pitfall: Architects have neglected important NN tasks.
 - CNNs constitute only about 5% of the representative NN workload for Google. More attention should be paid to MLPs and LSTMs. Repeating history, it's similar to when many architects concentrated on floating-point performance when most mainstream workloads turned out to be dominated by integer operations.
- Pitfall: Performance counters added as an afterthought for NN hardware. Fallacy: After two years of software tuning, the only path left to increase TPU performance is hardware upgrades.
- Pitfall: Being ignorant of architecture history when designing a domain-specific architecture
 - Systolic arrays
 - Decoupled-access/execute
 - CISC instructions

Final words

Conclusion

- Computer architecture is more important than you can ever imagine
- Being a "programmer" is easy. You need to know architecture a lot to be a "performance programmer"
 - Branch prediction
 - Cache
- Multicore era to get your multithreaded program correct and perform well, you need to take care of coherence and consistency
- We're now in the "dark silicon era"
 - Single-core isn't getting any faster
 - Multi-core doesn't scale anymore
 - We will see more and more ASICs
 - You need to write more "system-level" programs to use these new ASICs.
- Interested in latest architecture/system research? Joining EE260 next quarter

Announcement

- Final Exam next Monday @ 8am
- Homework #4 due tonight
- iEval submission attach your "confirmation" screen, you get an extra/bonus homework
- Office hour for Hung-Wei this week MWF 1p-2p

Helper thread contest

- Top Yu-Ching Hu
- Runner-up Irfan Ahmed Vezhapillil Aboobacker
- Honorable mention Abenezer Wudenhe



Thank you all for this great quarter!

